

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT8028426

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	NUNC PRO TUNC ASSIGNMENT
EFFECTIVE DATE:	06/07/2023
SEQUENCE:	1

CONVEYING PARTY DATA

Name	Execution Date
MICHAEL LEE SIMPSON	01/11/2021
MATTHEW JAMES BICKERTON	01/11/2021

RECEIVING PARTY DATA

Name:	FLAT PLANET LIMITED
Street Address:	11-12 TAK HING STREET
Internal Address:	ROOM 1407 RIGHTFUL CENTRE
City:	KOWLOON
State/Country:	HONG KONG

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17259461

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 2126618000
Email: info@lmiplaw.com
Correspondent Name: LUCAS & MERCANTI, LLP
Address Line 1: 30 BROAD STREET
Address Line 2: 21ST FLOOR
Address Line 4: NEW YORK, NEW YORK 10004

ATTORNEY DOCKET NUMBER:	SW-745
NAME OF SUBMITTER:	ELIZABETH LEE D'AMORE
SIGNATURE:	/Elizabeth Lee D'Amore/
DATE SIGNED:	06/27/2023

Total Attachments: 2

source=NUNC PRO TUNC ASSIGNMENT_inventorsexecuted#page1.tif
 source=NUNC PRO TUNC ASSIGNMENT_inventorsexecuted#page2.tif

NUNC PRO TUNC ASSIGNMENT

WHEREAS, **Michael Lee Simpson**, of Santa Monica, CA, and **Matthew James Bickerton**, of Topanga, CA, hereinafter called "ASSIGNOR," have invented and own certain new and useful inventions and discoveries, for which patent applications have been filed or patents granted, as identified on the attached Schedule, and

WHEREAS, **Flat Planet Limited**, having a place of business at Room 1407 Rightful Centre, 11-12 Tak Hing Street, Kowloon, Hong Kong, hereinafter called "ASSIGNEE," is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries on the respective application filing dates of the patents identified in the Schedule, and ASSIGNEE thereby acquired all of ASSIGNOR's title, rights, benefits, and privileges in the patents identified in the Schedule.

NOW, THEREFORE, for valuable consideration furnished by ASSIGNEE to ASSIGNOR, receipt and sufficiency of which is hereby acknowledged, ASSIGNOR hereby, without reservation, confirms that it did, and hereby does:

1. Assign, transfer, and convey to ASSIGNEE its entire right, title, and interest in and to the patents identified in the Schedule, including all inventions and discoveries encompass thereby, all applications for Letters Patent of the United States of America, any and all other applications for Letters Patent on said inventions and discoveries in whatsoever countries, including all divisional, renewal, substitute, continuation, and Convention applications based in whole or in part upon the patents identified in the Schedule, said inventions or discoveries, or upon said applications, and any and all Letters Patents, reissues, and extensions of Letters Patents granted for said inventions and discoveries or upon said applications, and every priority right that is or may be predicated upon or arise from said inventions, said discoveries, said applications, and said Patents.


2. Authorizes ASSIGNEE to file patent applications in any or all countries for any or all of said inventions and discoveries in ASSIGNOR's name or in the name of ASSIGNEE or otherwise as ASSIGNEE may deem advisable, under the International Convention or otherwise.

3. Authorizes and requests the Commissioner of Patents and Trademarks of the United States of America and the empowered officials of all other governments to issue or transfer all said Letters Patents to ASSIGNEE, as assignee of the entire right, title, and interest therein or otherwise as ASSIGNEE may direct.

IN TESTIMONY WHEREOF, ASSIGNOR has signed below, and all assignments shall be recorded *nunc pro tunc* on the patent application's filing date identified in the Schedule.



Michael Lee Simpson



Matthew James Bickerton

SCHEDULE

Patent No.	Patent Application No.	Patent Application Date	Title
11,491,299	16/945,665	07-31-2020	Dual Convection and Conduction Oven for Flower Stick
	18/053,387	11-8-2022	Temperature Profiles for Operating a Dual Convection and Conduction Oven
	16/509,469	7-11-2019	Flower Cartridge Crimping and Filling for Herb Delivery
	17/259,461	1-11-2021	Flower Cartridge for Herb Delivery
	62/696,765	7-11-2018	Herb Delivery Sticks and Heater
	62/836,641	4-20-2019	Herb Delivery System and Filling Method
	63/059,894	7-31-2020	Dual Convection and Conduction Oven for Flower Stick
	63/236,608	8-24-2021	Home Fill Kit for Flower Stick

{00875871 }